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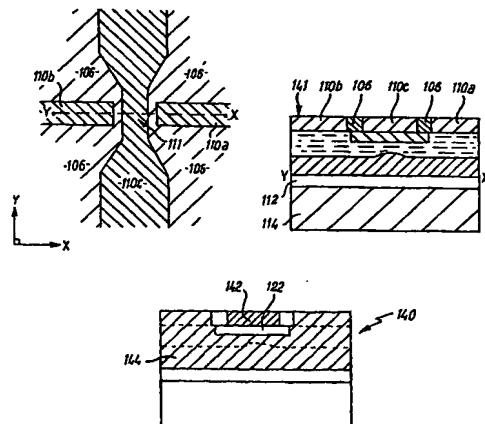
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(54) Title: A CROSS-OVER OF CONDUCTIVE INTERCONNECTS AND A METHOD OF CROSSING CONDUCTIVE INTERCONNECTS



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(57) Abstract: A cross-over (140) of first (142) and second (144) separate elongate conductive interconnects, comprising: a first elongate conductive interconnect (142); a first conductive portion (110a) separate from the first elongate conductive interconnect (142); a second conductive portion (110b) separate from the first elongate conductive interconnect (142); first insulating material (122) adjacent at least a portion (111) of the first elongate conductive interconnect (142); and a third electro-deposited metal portion (124) extending adjacent the first insulating material (122) to interconnect the first (110a) and second (110b) conductive portions, wherein the first (110a), second (110b) and third (124) portions are interconnected portions of the second elongate conductive interconnect (144); and a substrate, wherein the first insulating material and the third electro-deposited metal portion are positioned between the substrate and the first elongate conductive interconnect.



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